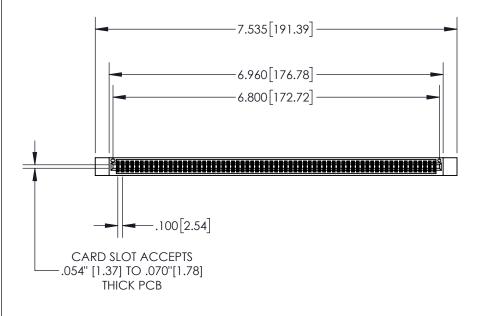
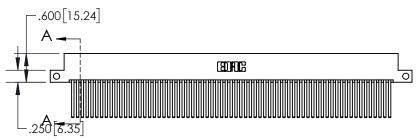
Contact Dimensions: 544-Wire Wrap .050x.025(1.27x0.64) - Tail LG=.750(19.05) .100 (2.54) Contact Spacing x .200 (5.08) Row Spacing



1





.330[8.38] **CARD SLOT** .370 [9.40] **SECTION A-A** .160 4.06 POINT OF **CONTACT -**.200 [5.08]

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
 - CONTACT MATERIAL; COPPER TIN ALLOY
 CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
 ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895	SERIES HIGH TEMP	CARD EDG	E CONNECTOR
PART NUI	MBFR: 845-134-544	4-212	

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER			
DRAWN: R.	STA.MONICA	DATE:MA	Y.16/2017
CHECKED:		DATE:	
SCALE:	1:2	SHEET 1	OF 2
DRAWING NUMBER			ISSUE

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

Contact Code 558

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

Contact Code 559

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

Contact Code 560

845-ENG-MASTER